



**THE DATASHEET OF
PMK50XP,518**





PMK50XP

P-channel TrenchMOS extremely low level FET

Rev. 02 — 28 April 2010

Product data sheet

1. Product profile

1.1 General description

Extremely low level P-channel enhancement mode Field-Effect Transistor (FET) in a plastic package using TrenchMOS technology. This product is designed and qualified for use in computing, communications, consumer and industrial applications only.

1.2 Features and benefits

- Low conduction losses due to low on-state resistance

1.3 Applications

- Battery management
- Load switching

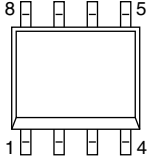
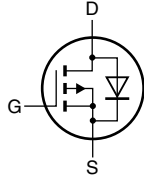
1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{DS}	drain-source voltage	$25\text{ °C} \leq T_j \leq 150\text{ °C}$	-	-	-20	V
I_D	drain current	$T_{sp} = 25\text{ °C}$; $V_{GS} = -4.5\text{ V}$; see Figure 1 ; see Figure 3	-	-	-7.9	A
P_{tot}	total power dissipation	$T_{sp} = 25\text{ °C}$; see Figure 2	-	-	5	W
Static characteristics						
R_{DSon}	drain-source on-state resistance	$V_{GS} = -4.5\text{ V}$; $I_D = -2.8\text{ A}$; $T_j = 25\text{ °C}$; see Figure 9 ; see Figure 10	-	40	50	mΩ
Dynamic characteristics						
Q_{GD}	gate-drain charge	$V_{GS} = -4.5\text{ V}$; $I_D = -4.7\text{ A}$; $V_{DS} = -10\text{ V}$; see Figure 11 ; see Figure 12	-	1.3	-	nC

2. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source	 <p>SOT96-1 (SO8)</p>	 <p>003aaa671</p>
2	S	source		
3	S	source		
4	G	gate		
5	D	drain		
6	D	drain		
7	D	drain		
8	D	drain		

3. Ordering information

Table 3. Ordering information

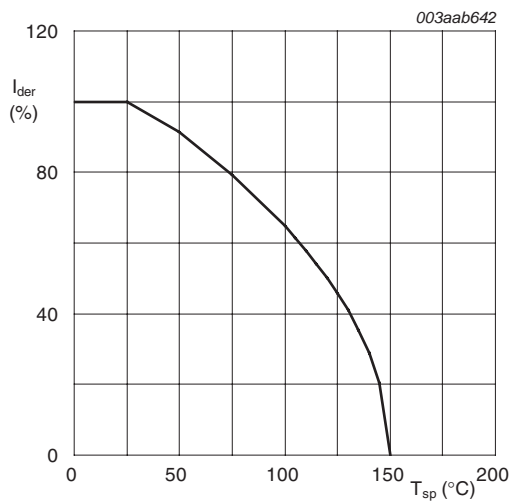
Type number	Package		Version
	Name	Description	
PMK50XP	SO8	plastic small outline package; 8 leads; body width 3.9 mm	SOT96-1

4. Limiting values

Table 4. Limiting values

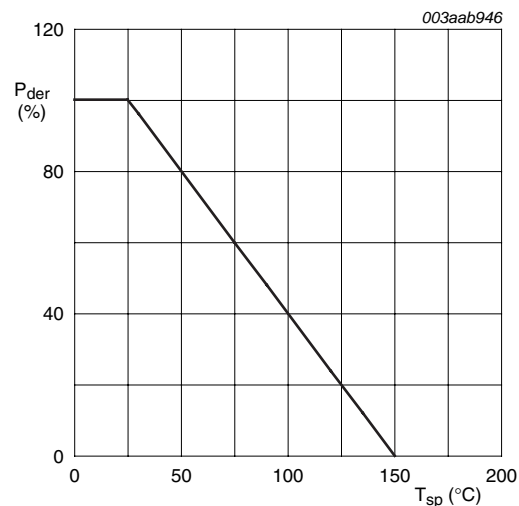
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{DS}	drain-source voltage	$25\text{ °C} \leq T_j \leq 150\text{ °C}$	-	-	-20	V
V_{DGR}	drain-gate voltage	$25\text{ °C} \leq T_j \leq 150\text{ °C}$; $R_{GS} = 20\text{ k}\Omega$	-	-	-20	V
V_{GS}	gate-source voltage		-12	-	12	V
I_D	drain current	$T_{sp} = 25\text{ °C}$; $V_{GS} = -4.5\text{ V}$; see Figure 1 ; see Figure 3	-	-	-7.9	A
		$T_{sp} = 100\text{ °C}$; $V_{GS} = -4.5\text{ V}$; see Figure 1	-	-	-5	A
I_{DM}	peak drain current	$T_{sp} = 25\text{ °C}$; $t_p \leq 10\text{ }\mu\text{s}$; pulsed; see Figure 3	-	-	-31.6	A
P_{tot}	total power dissipation	$T_{sp} = 25\text{ °C}$; see Figure 2	-	-	5	W
T_{stg}	storage temperature		-55	-	150	°C
T_j	junction temperature		-55	-	150	°C
Source-drain diode						
I_S	source current	$T_{sp} = 25\text{ °C}$	-	-	-4.1	A
I_{SM}	peak source current	$T_{sp} = 25\text{ °C}$; $t_p \leq 10\text{ }\mu\text{s}$; pulsed	-	-	-16.4	A



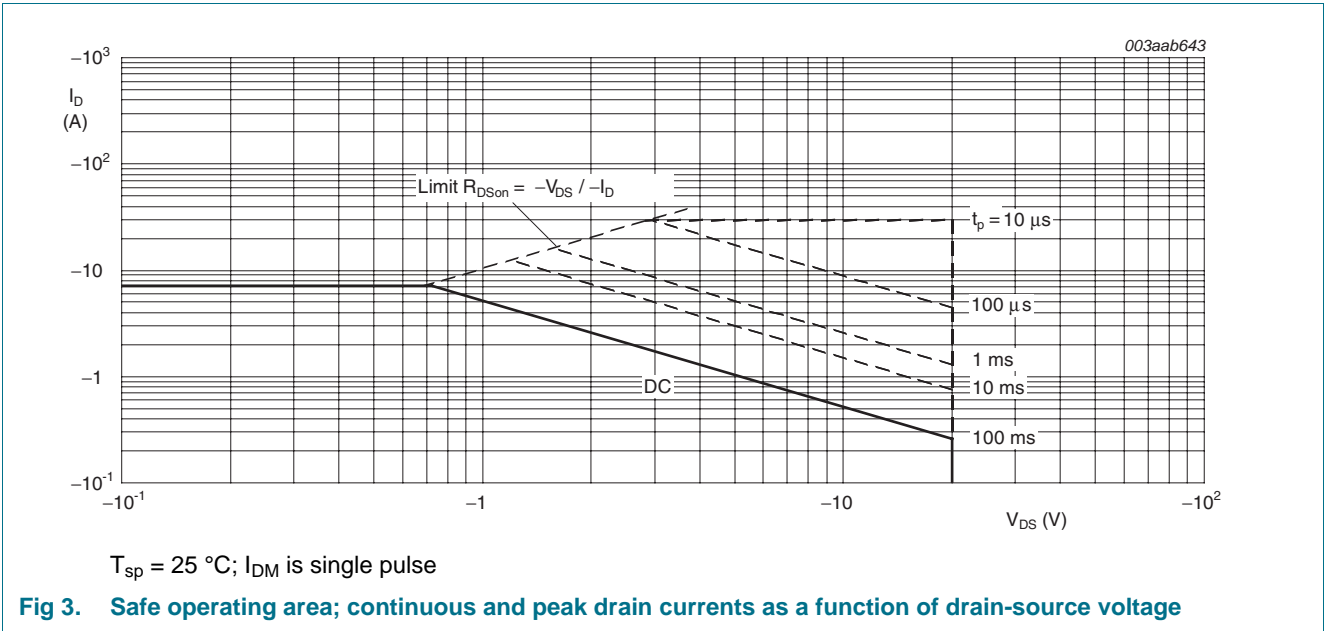
$$I_{der} = \frac{I_D}{I_{D(25^\circ\text{C})}} \times 100\%$$

Fig 1. Normalized continuous drain current as a function of solder point temperature



$$P_{der} = \frac{P_{tot}}{P_{tot(25^\circ\text{C})}} \times 100\%$$

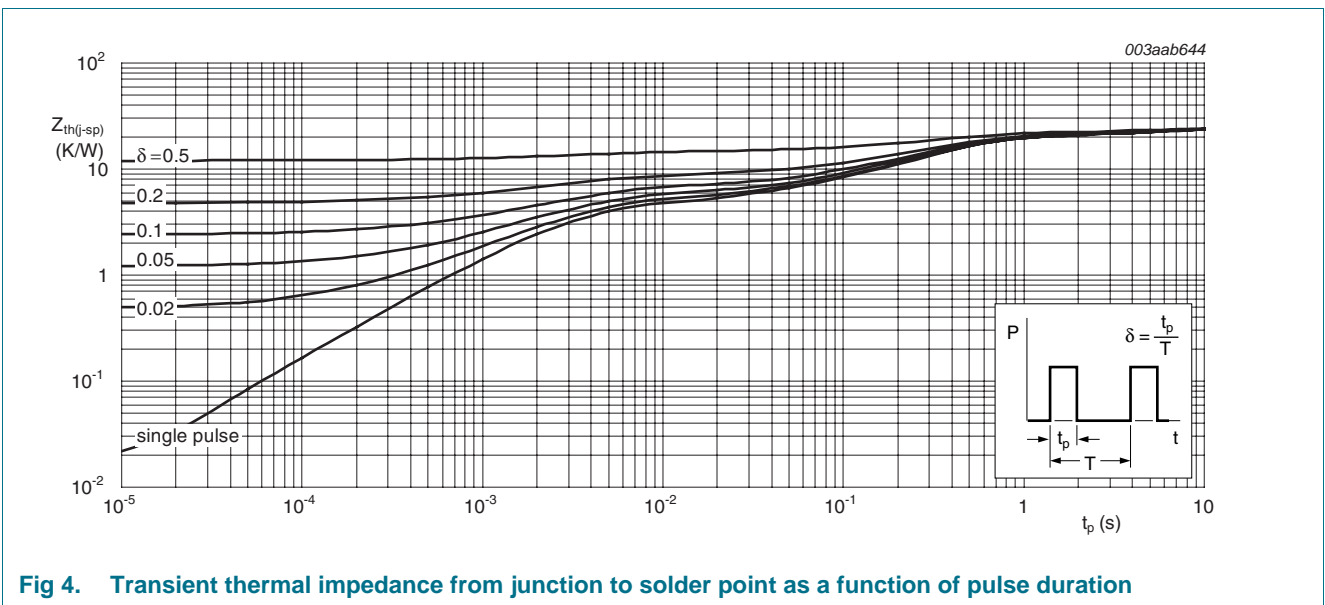
Fig 2. Normalized total power dissipation as a function of solder point temperature



5. Thermal characteristics

Table 5. Thermal characteristics

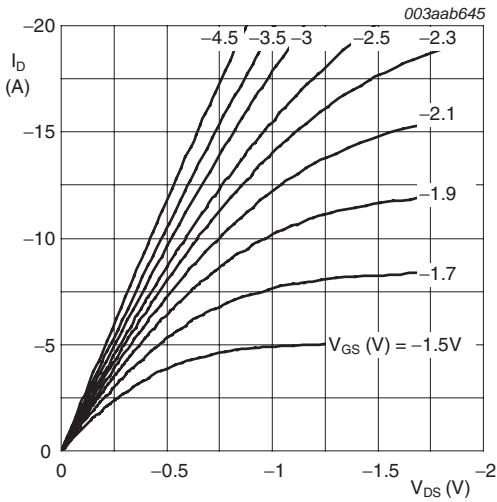
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$R_{th(j-sp)}$	thermal resistance from junction to solder point	see Figure 4	-	-	25	K/W



6. Characteristics

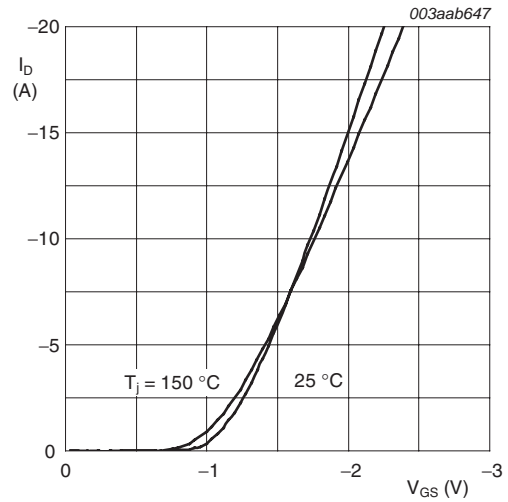
Table 6. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static characteristics						
$V_{(BR)DSS}$	drain-source breakdown voltage	$I_D = -250 \mu A$; $V_{GS} = 0 V$; $T_j = -55 \text{ }^\circ\text{C}$	-18	-	-	V
		$I_D = -250 \mu A$; $V_{GS} = 0 V$; $T_j = 25 \text{ }^\circ\text{C}$	-20	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	$I_D = -250 \mu A$; $V_{DS} = V_{GS}$; $T_j = -55 \text{ }^\circ\text{C}$; see Figure 7 ; see Figure 8	-	-	-1.1	V
		$I_D = -250 \mu A$; $V_{DS} = V_{GS}$; $T_j = 150 \text{ }^\circ\text{C}$; see Figure 7 ; see Figure 8	-0.35	-	-	V
		$I_D = -250 \mu A$; $V_{DS} = V_{GS}$; $T_j = 25 \text{ }^\circ\text{C}$; see Figure 7 ; see Figure 8	-0.55	-0.75	-0.95	V
I_{DSS}	drain leakage current	$V_{DS} = -20 V$; $V_{GS} = 0 V$; $T_j = 25 \text{ }^\circ\text{C}$	-	-	-1	μA
		$V_{DS} = -20 V$; $V_{GS} = 0 V$; $T_j = 70 \text{ }^\circ\text{C}$	-	-	-5	μA
I_{GSS}	gate leakage current	$V_{GS} = 12 V$; $V_{DS} = 0 V$; $T_j = 25 \text{ }^\circ\text{C}$	-	-10	-100	nA
		$V_{GS} = -12 V$; $V_{DS} = 0 V$; $T_j = 25 \text{ }^\circ\text{C}$	-	-10	-100	nA
$R_{DS(on)}$	drain-source on-state resistance	$V_{GS} = -2.5 V$; $I_D = -2.3 A$; $T_j = 25 \text{ }^\circ\text{C}$; see Figure 9 ; see Figure 10	-	56	70	m Ω
		$V_{GS} = -4.5 V$; $I_D = -2.8 A$; $T_j = 150 \text{ }^\circ\text{C}$; see Figure 9 ; see Figure 10	-	64	80	m Ω
		$V_{GS} = -4.5 V$; $I_D = -2.8 A$; $T_j = 25 \text{ }^\circ\text{C}$; see Figure 9 ; see Figure 10	-	40	50	m Ω
Dynamic characteristics						
$Q_{G(tot)}$	total gate charge	$I_D = -4.7 A$; $V_{DS} = -10 V$; $V_{GS} = -4.5 V$; see Figure 11 ; see Figure 12	-	10	-	nC
Q_{GS}	gate-source charge		-	2.2	-	nC
Q_{GD}	gate-drain charge		-	1.3	-	nC
$V_{GS(pl)}$	gate-source plateau voltage	$I_D = -4.7 A$; $V_{DS} = -10 V$; see Figure 11 ; see Figure 12	-	-1.6	-	V
C_{iss}	input capacitance	$V_{DS} = -20 V$; $V_{GS} = 0 V$; $f = 1 \text{ MHz}$; $T_j = 25 \text{ }^\circ\text{C}$; see Figure 13	-	1020	-	pF
C_{oss}	output capacitance		-	140	-	pF
C_{rss}	reverse transfer capacitance		-	100	-	pF
$t_{d(on)}$	turn-on delay time	$V_{DS} = -10 V$; $R_L = 10 \Omega$; $V_{GS} = -4.5 V$; $R_{G(ext)} = 6 \Omega$	-	8.5	-	ns
t_r	rise time		-	7.5	-	ns
$t_{d(off)}$	turn-off delay time		-	82	-	ns
t_f	fall time		-	35	-	ns
Source-drain diode						
V_{SD}	source-drain voltage	$I_S = -1.7 A$; $V_{GS} = 0 V$; $T_j = 25 \text{ }^\circ\text{C}$; see Figure 14	-	-0.77	-1.2	V



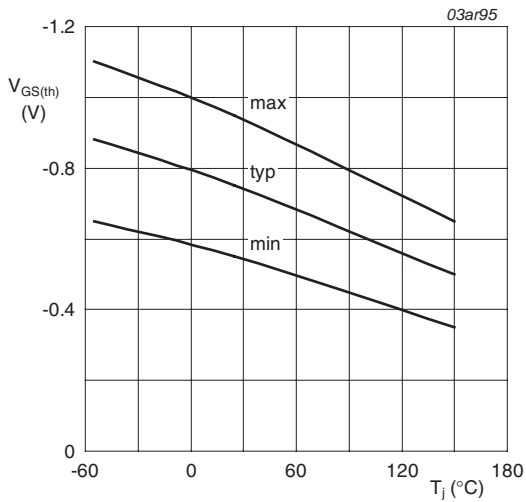
$T_j = 25\text{ }^\circ\text{C}$

Fig 5. Output characteristics: drain current as a function of drain-source voltage; typical values



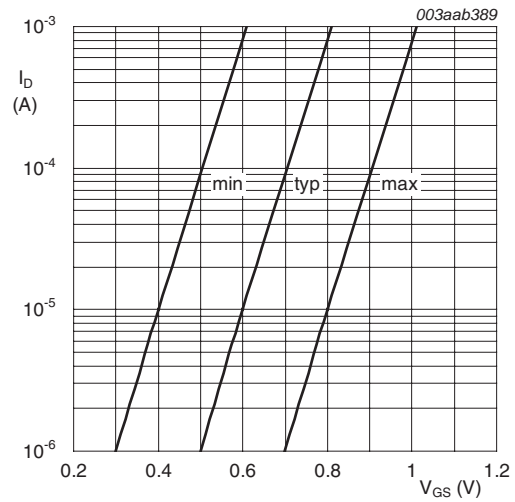
$V_{DS} > I_D \times R_{DSon}$

Fig 6. Transfer characteristics: drain current as a function of gate-source voltage; typical values



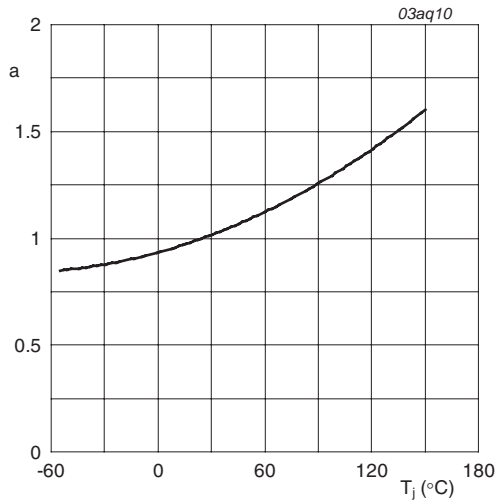
$I_D = -0.25\text{ mA}; V_{DS} = V_{GS}$

Fig 7. Gate-source threshold voltage as a function of junction temperature



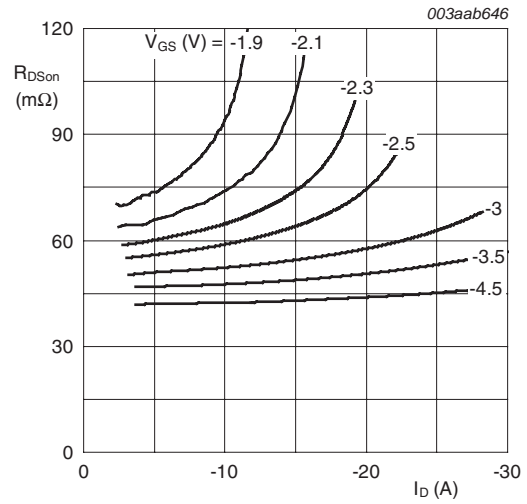
$T_j = 25\text{ }^\circ\text{C}; V_{DS} = -5\text{ V}$

Fig 8. Sub-threshold drain current as a function of gate-source voltage



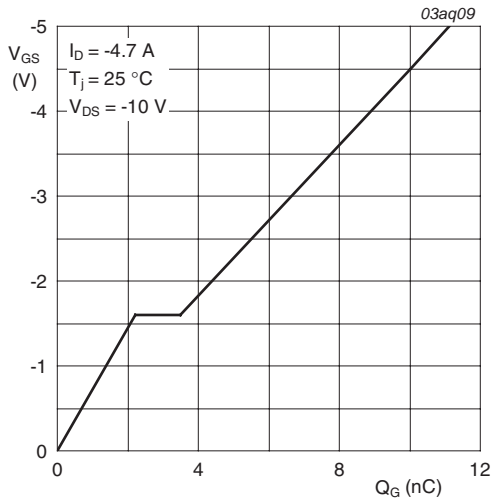
$$a = \frac{R_{DSon}}{R_{DSon(25^{\circ}C)}}$$

Fig 9. Normalized drain-source on-state resistance factor as a function of junction temperature



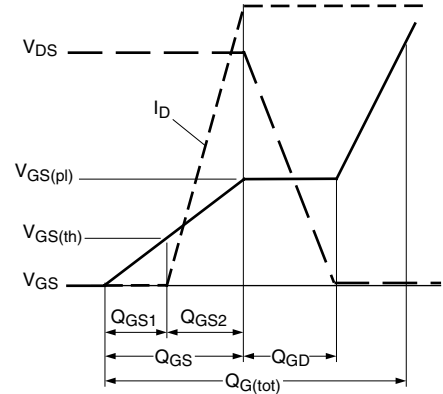
$T_j = 25^{\circ}C$

Fig 10. Drain-source on-state resistance as a function of drain current; typical values



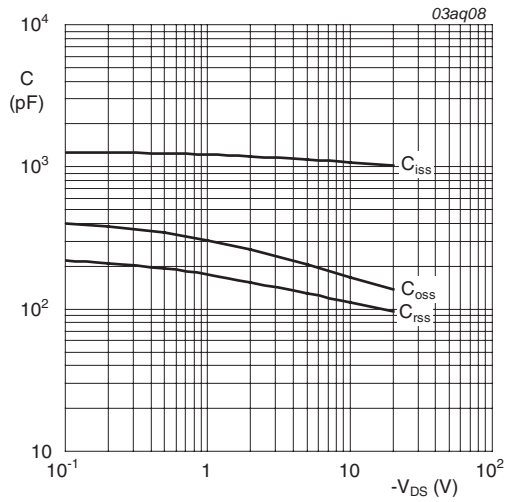
$I_D = -4.7 A; T_j = 25^{\circ}C; V_{DS} = -10 V$

Fig 11. Gate-source voltage as a function of gate charge; typical values



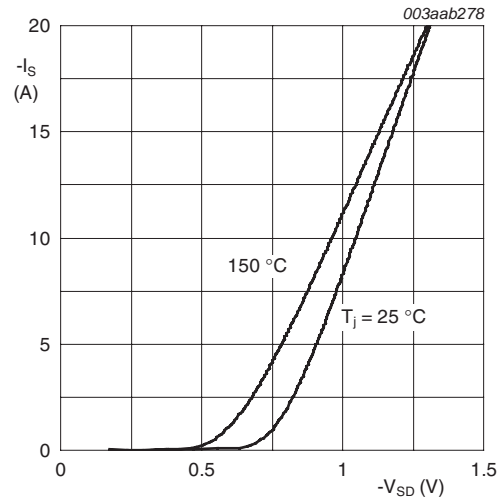
003aaa508

Fig 12. Gate charge waveform definitions



$V_{GS} = 0 \text{ V}; f = 1 \text{ MHz}$

Fig 13. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values



$V_{GS} = 0 \text{ V}$

Fig 14. Source current as a function of source-drain voltage; typical values

7. Package outline

SO8: plastic small outline package; 8 leads; body width 3.9 mm

SOT96-1

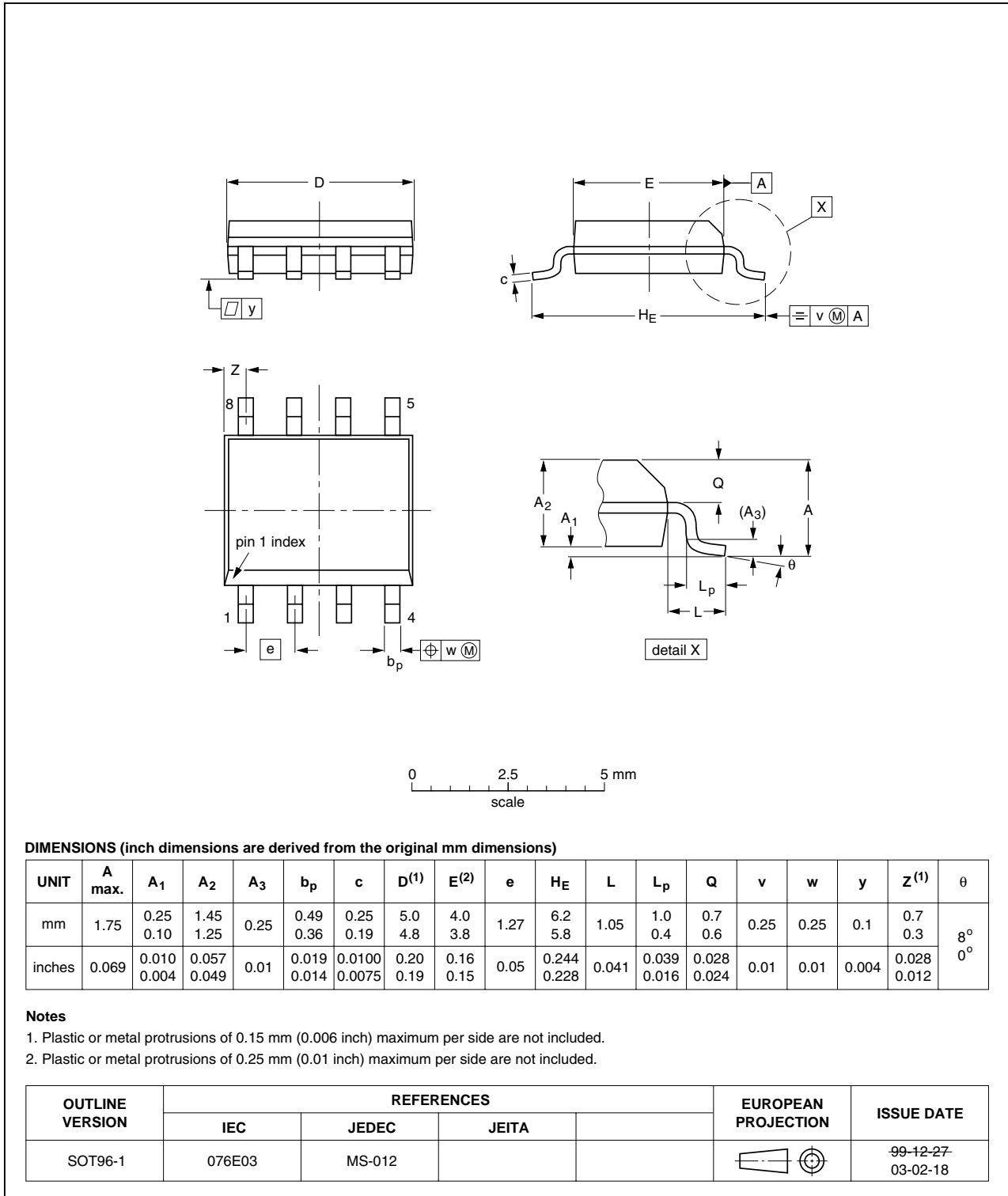


Fig 15. Package outline SOT96-1 (SO8)

8. Revision history

Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PMK50XP_2	20100428	Product data sheet	-	PMK50XP_1
Modifications:	• Various changes to content.			
PMK50XP_1	20070917	Product data sheet	-	-

9. Legal information

9.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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